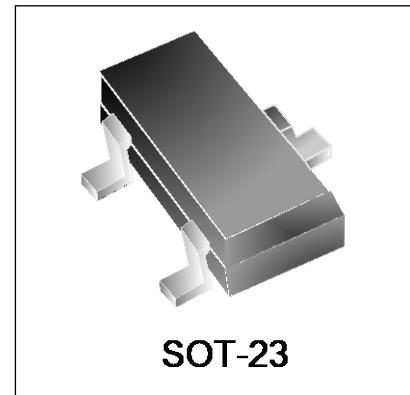


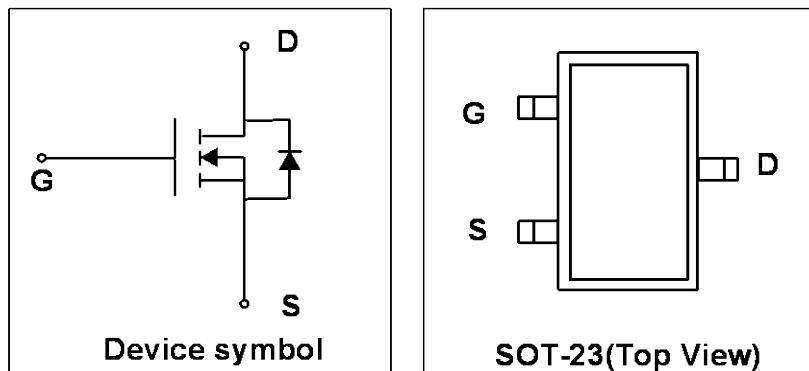
N-Channel Enhancement MOSFET

Features

- Way-on Small Signal MOSFETs
- $V_{DS} = 30 \text{ V}$, $I_D = 5.8 \text{ A}$
- $R_{DS(on)} < 27\text{m}\Omega @ V_{GS} = 10 \text{ V}$
- $R_{DS(on)} < 38\text{m}\Omega @ V_{GS} = 4.5\text{V}$
- Trench LV MOSFET Technology

**Mechanical Characteristics**

- SOT-23 Package
- Marking : Making Code
- RoHS Compliant

Schematic & PIN Configuration**Absolute Maximum Rating ($T_A=25^\circ\text{C}$ unless otherwise noted)**

Parameter		Symbol	Value	Unit
Drain-Source Voltage		V_{DS}	30	V
Gate-Source Voltage		V_{GS}	± 20	V
Continuous Drain Current	$T_A=25^\circ\text{C}$	I_D	5.8	A
Pulsed Drain Current ¹		I_{DM}	30	A
Power Dissipation	$T_A=25^\circ\text{C}$	P_D	1.2	W
Operating Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction to Ambient ²	$R_{\theta JA}$	104	$^\circ\text{C/W}$

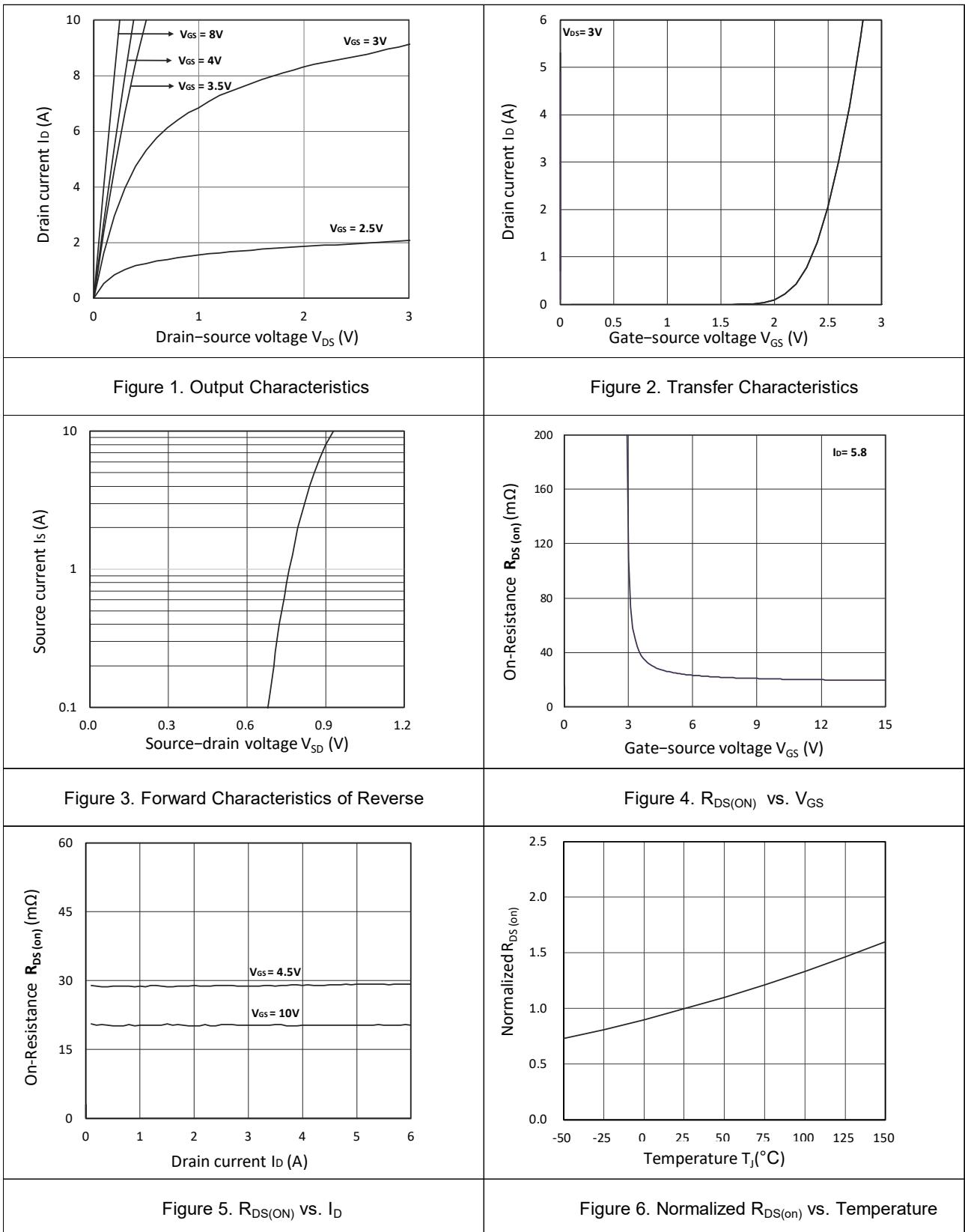
Electrical Characteristics (T_J=25°C unless otherwise specified)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250µA	30	-	-	V
Zero Gate Voltage Drain Current	I _{DS}	V _{DS} = 30V, V _{GS} = 0 V	-	-	1	µA
Gate-Body Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±20V	-	-	±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{GS} = V _{DS} , I _D = 250µA	1	1.5	2.5	V
Drain-Source on-State Resistance ³	R _{DS(on)}	V _{GS} = 10V, I _D = 5.8A	-	20	27	mΩ
		V _{GS} = 4.5V, I _D = 4.8A	-	29	38	
Dynamic Characteristics⁴						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 15V, f = 1MHz	-	500	-	pF
Output Capacitance	C _{oss}		-	72	-	
Reverse Transfer Capacitance	C _{rss}		-	58	-	
Switching Characteristics⁴						
Total Gate Charge	Q _g	V _{GS} = 10V, V _{DS} = 15V, I _D = 5.8A	-	9.8	-	nC
Gate-Source Charge	Q _{gs}		-	1.5	-	
Gate-Drain Charge	Q _{gd}		-	1.6	-	
Turn-on Delay Time	t _{d(on)}	V _{GS} = 10V, V _{DD} = 15V, I _D = 5.8A, R _G = 3Ω	-	4.7	-	ns
Turn-on Rise Time	t _r		-	1.3	-	
Turn-off Delay Time	t _{d(off)}		-	13	-	
Turn-off Fall Time	t _f		-	3	-	
Source-Drain Diode Characteristics						
Body Diode Voltage ³	V _{SD}	I _S = 1A, V _{GS} = 0V	-	-	1	V
Continuous Source Current	I _S		-	-	5.8	A

Notes:

1. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)} = 150°C.
2. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper, The value in any given application depends on the user's specific board design.
3. Pulse Test: Pulse width ≤ 300µs, duty cycle ≤ 2%.
4. This value is guaranteed by design hence it is not included in the production test.

Typical Characteristics



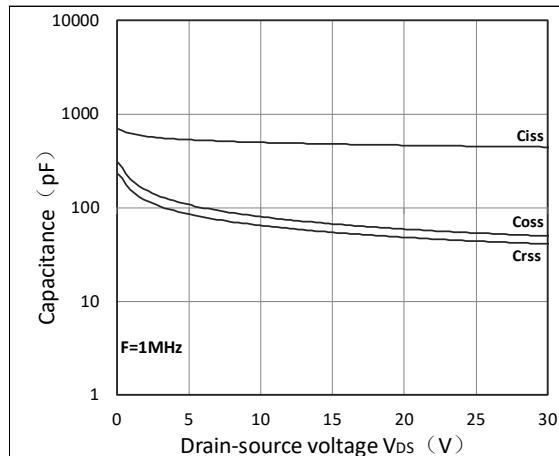


Figure 7. Capacitance Characteristics

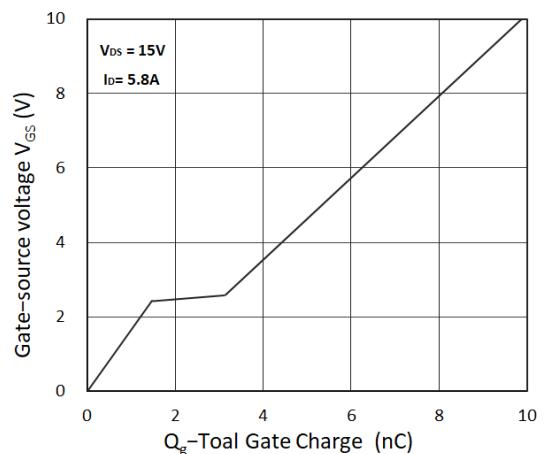


Figure 8. Gate Charge Characteristics

Outline Drawing – SOT-23

PACKAGE OUTLINE		DIMENSIONS			
SYMBOL	MILLIMETER		INCHES		
	MIN	MAX	MIN	MAX	
A	0.90	1.15	0.035	0.045	
A1	0.00	0.10	0.000	0.004	
b	0.30	0.50	0.012	0.020	
c	0.08	0.15	0.003	0.006	
D	2.80	3.00	0.110	0.118	
E	2.25	2.55	0.089	0.100	
E1	1.20	1.40	0.047	0.055	
e	0.95 BSC		0.037BSC		
e1	1.80	2.00	0.071	0.079	
L	0.55REF		0.022REF		
L1	0.30	0.50	0.012	0.020	
θ	0°	8°	0°	8°	

DIMENSIONS		
DIM	INCHES	MILLIMETERS
M	0.080	2.02
C	0.032	0.80
Z	0.111	2.82
e	0.037 BSC	0.95 BSC
e1	0.075 BSC	1.90 BSC
b	0.032	0.80

Notes

- Dimensioning and tolerances per ANSI Y14.5M, 1985.
- Controlling Dimension: Inches
- Pin 3 is the cathode (Unidirectional Only).
- Dimensions are exclusive of mold flash and metal burrs.

Marking Codes

Part Number	WM03N57M
Marking Code	R4

Package Information

Qty: 3k/Reel

CONTACT INFORMATION

No.1001, Shiwan (7) Road, Pudong District, Shanghai, P.R.China.201207

Tel: 86-21-68969993 Fax: 86-21-50757680 Email: market@way-on.com

WAYON website: <http://www.way-on.com>

For additional information, please contact your local Sales Representative.

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Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time. Users should verify actual device performance in their specific applications.